NUP8010MN

Low Capacitance Transient Voltage Suppressor Array

This integrated transient voltage suppressor device (TVS) is designed for applications requiring transient overvoltage protection. It is intended for use in sensitive equipment such as computers, printers, business machines, communication systems, medical equipment, and other applications. Its integrated design provides very effective and reliable protection for eight separate lines using only one package. These devices are ideal for situations where board space is at a premium.

Features

- Low Capacitance
- Low Leakage Current < 1 μA @ 3 V
- ESD Ratings:
 - IEC61000-4-2, 8 kV (Contact)
 - ◆ IEC61000-4-2, 15 kV (Air)
 - Machine Model = Class C, 400 V
 - ♦ Human Body Model = Class 3B, 8 kV
- DFN Package, 1.6 x 1.6 mm
- Moisture Sensitivity Level 1
- This is a Pb-Free Device

Benefits

- Provides Protection for ESD Industry Standards: IEC 61000, HBM
- Protects the Line Against Transient Voltage Conditions in Either Direction
- Minimize Power Consumption of the System
- Minimize PCB Board Space

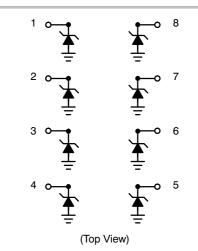
Applications

- ESD Protection for Data Lines
- Wireless Phones
- Handheld Products
- Notebook Computers
- LCD Displays



ON Semiconductor®

http://onsemi.com



MARKING DIAGRAM



1

DFN8 CASE 506AK



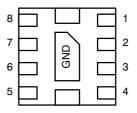
5P = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS



(Bottom View)

ORDERING INFORMATION

| Device | Package | Shipping |
|--------------|-------------------|--------------------|
| NUP8010MNT1G | DFN8 (Pb-Free) | 3000 / Tape & Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NUP8010MN

MAXIMUM RATINGS

| Parameter | Symbol | Value | Unit |
|---|-----------------------------|------------|------|
| ESD Discharge IEC61000-4-2 Air Discharge Contact Discharge | V _{PP} | 15 8.0 | kV |
| Peak Power Dissipation (8 x 20 μS @ T _A = 25°C) | P _{pk} (Note 1) | 20 | W |
| Operating Temperature Range | T _{OP} | -40 to 85 | °C |
| Storage Temperature Range | T _{STG} | -55 to 150 | °C |
| Maximum Lead Temperature for Soldering Purposes (1.8 in from case for 10 seconds) | TL | 260 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

| Parameter | Symbol | Test Conditions | Min | Тур | Max | Unit |
|---------------------------------|------------------|-----------------------------------|-----|------|------|------|
| Maximum Reverse Working Voltage | V _{RWM} | | | | 3.0 | V |
| Breakdown Voltage | V_{BR} | I _R = 1.0 mA | 5.3 | 5.6 | 5.9 | V |
| Leakage Current | I _R | V _{RWM} = 3.3 V | | 0.01 | 1.0 | μΑ |
| Clamping Voltage | V _c | I _{PP} = 1.6 A | | | 13 | V |
| Capacitance | C _d | f = 1 MHz, V _R = 0 V | | 13 | 17 | pF |
| Capacitance | C _d | f = 1 MHz, V _R = 3.0 V | | 7.0 | 11.5 | pF |

^{1.} Nonrepetitive current per Figure 4.

NUP8010MN

TYPICAL PERFORMANCE CURVES (T_A= 25°C unless otherwise specified)

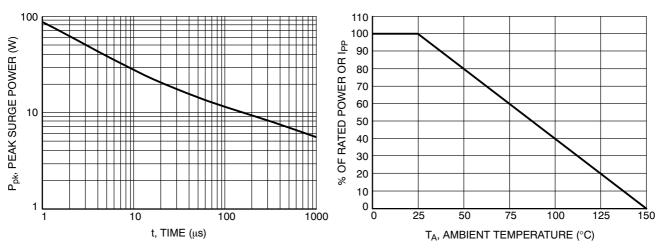


Figure 1. Pulse Width

Figure 2. Power Derating Curve

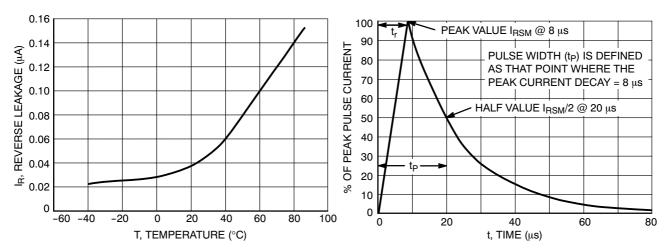


Figure 3. Reverse Leakage versus Temperature

Figure 4. $8 \times 20~\mu s$ Pulse Waveform

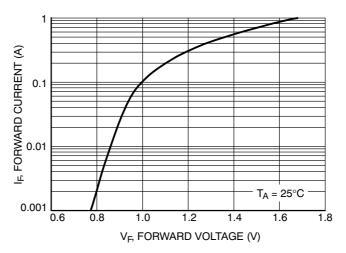
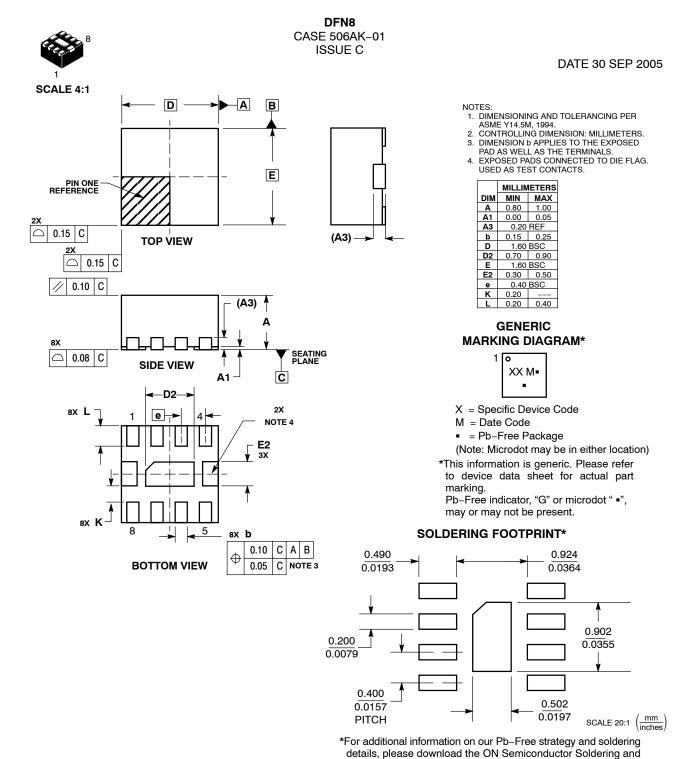


Figure 5. Forward Voltage



| DOCUMENT NUMBER: | 98AON20130D | Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | |
|------------------|-----------------------------------|---|-------------|
| DESCRIPTION: | DFN8 1.6*1.6 MM 0.4 MM LEAD PITCH | | PAGE 1 OF 1 |

Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative